

**DECLARATION AND POWER OF ATTORNEY
FOR PATENT APPLICATION
(Joint Inventors)**

We as the below named inventors, declare that:

Our residences, post office addresses and citizenships are as stated below next to our names.

We believe we are the original, first and joint inventors of the subject matter which is claimed and for which patent is sought on the invention entitled:

**TEST INTERCONNECT FOR BUMPED SEMICONDUCTOR
COMPONENTS AND METHOD OF FABRICATION**

the specification of which (check one)

☒ is attached hereto.

☐ was filed on _____ as Application
Serial No. _____.

and was amended on (if applicable) _____.

We hereby state that we have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

We acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Sec. 1.56(a).

We hereby claim foreign priority under Title 35, United States Code, Sec. 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed: NONE

We hereby claim the benefit under Title 35, United States Code, Sec. 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Sec. 11, we acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, Sec. 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application: NONE

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Telephone: (303) 989 6353
Fax: (303) 989 6538

Wherefore, we pray that Letters Patent be granted to us for the invention or discovery described and claimed in the foregoing specification and claims, declaration, power of attorney, and this petition.

WARREN M. FARNWORTH

Plan for Feb

3-8-99

Nampa, Idaho

United States of America

2004 S. Banner
Nampa, ID 83786

INVENTOR'S FULL NAME:

SALMAN AKRAM

INVENTOR'S SIGNATURE:

Salman Akram

DATE OF SIGNATURE:

3/8/1999

RESIDENCE (CITY AND STATE)

Boise, Idaho

CITIZENSHIP:

Pakistan

POST OFFICE ADDRESS:

1463 E. Regatta Street
Boise, ID 83706

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